# MSKSEMI 美森科













ESD

TVS

TSS

MOV

GDT

PLED

# ESD05V14T-LC-MS

## **Product specification**





### FEATURES

- Ultra low leakage: nA level
- Operating voltage: 5V
- Low clamping voltage
- Complies with following standards:
- IEC 61000-4-2 (ESD) immunity test Air

discharge: ± 15kV

- Contact discharge: ±8kV
- IEC61000-4-4 (EFT) 40A (5/50ns)
- IEC61000-4-5 (Lightning) 3A

(8/20µs) RoHS Compliant

## MACHANICAL DATA

- SOT-143 package
- Flammability Rating: UL 94V-0
- Packaging: Tape and Reel
- High temperature soldering guaranteed: 260°C/10s
- Reel size: 7 inch

## APPLICATIONS

- USB 2.0 power and data line
- Set-top box and digital TV
- Digitalvideointerface (DVI)
- Notebook Computers
- SIM Ports
- 10/ 100 Ethernet

#### **Reference News**

PACKAGE OUTLINE	PIN CONFIGURATION	Marking
ALSIS CHI		R05
SOT-143		



#### **ABSOLUTE MAXIMUM RATING**

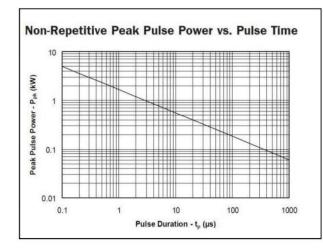
Symbol	Parameter	Value	Units
Ррр	Peak Pulse Power (8/20µs)	150	W
Vesd	ESD per IEC 61000-4-2 (Air)	±15	Kv
Vesd	ESD per IEC 61000-4-2 (Contact)	±8	Kv
TJ	Operating Temperature Range	-55 to + 125	°C
Тѕтј	Storage Temperature Range	-55 to + 150	C

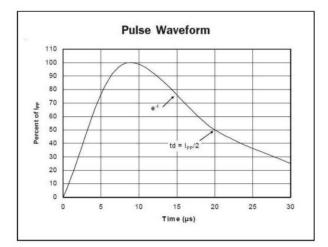
## ELECTRICAL CHARACTERISTICS (Tamb=25 °C)

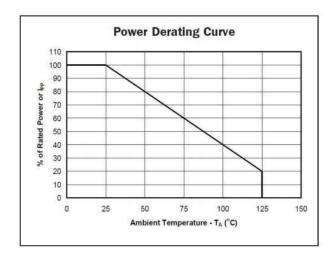
Symbol	Parameter	Test Condition	Min	Тур	Мах	Units
VRWM	Reverse Working Voltage				5.0	V
VBR	Reverse Breakdown Voltage	IT = 1mA	6.0			V
IR	Reverse Leakage Current	VRWM = 5V			100	nA
VC	Clamping Voltage	IPP = 1A, tp = 8/20µs			9.8	V
		IPP = 5 A, tp = 8/20µs			15	V
Сј	Junction Capacitance	VR = 0V, f = 1MHz		1.2		pF

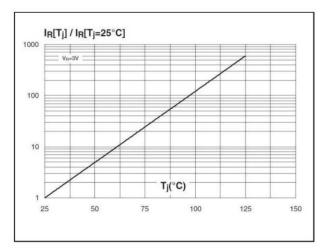


## **ELECTRICAL CHARACTERISTICS CURVE**



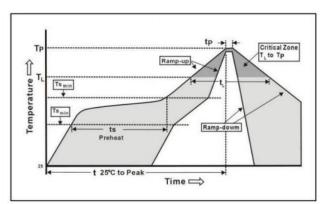






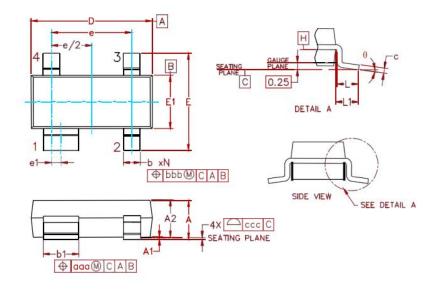
## **Soldering Parameters**

Reflow Condition		Fb – Free assembly	
Pre Heat	-Temperature Min (T <sub>s(Min)</sub> )	150°C	
	- Temperature Max (T <sub>s(Max)</sub> )	200°C	
	-Time (Min to max) (t <sub>s</sub> )	60 - 180 secs	
Average r (T <sub>L</sub> ) to pea	amp up rate (Liquidus) Temp Ik	3°C/second Max	
T <sub>S (Max)</sub> to T	- Ramp-up Rate	3°C/second Max	
Reflow	-Temperature (T <sub>1</sub> ) (Liquidus)	217°C	
	- Temperature (t <sub>i</sub> )	60 – 150 seconds	
Peak Temperature (T <sub>P</sub> )		250+0/-5 °C	
Time within 5°C of actual peak Temperature (t <sub>p</sub> )		20 – 40 seconds	
Ramp-dowm Rate		6°C/second Max	
Time 25°C to peak Temperature (T <sub>p</sub> )		8 minutes Max.	
Do not exceed		260°C	





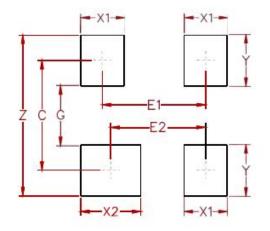
#### PACKAGE MECHANICAL DATA



	Inches		Millimeters		ers	
Symbol	Min.	Nom.	Max.	Min.	Nom.	Max
Α	0.031	•	0.048	0.80		1.22
A1	0.000		0.008	0.013		0.15
A2	0.020	0.035	0.042	0.75	0.90	1.07
b	0.011	•	0.020	0.30		0.51
b1	0.029		0.037	0.76		0.94
c	0.003		0.008	0.08		0.20
D	0.110	0.114	0.120	2.80	2.90	3.04
E	0.082	0.093	0.104	2.10	2.37	2.64
E1	0.047	0.051	0.055	1.20	1.30	1.40
е	0.075		1	.92 BS	С	
e1		0.008		0	.20 BS	С
L	0.015	0.020	0.024	0.40	0.50	0.60
L1	(0.021)				(0.54)	
N	4			4		
θ	0°	-	8°	0°	Υ.	8°
aaa	0.006		-	0.15		
bbb	0.008			0.20		
ccc	0.004				0.10	



Suggested Pad Layout



#### **REEL SPECIFICATION**

P/N	PKG	QTY
ESD05V14T-LC-MS	SOT-143	3000



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